AT93C86A

Atmel

3-wire Serial EEPROM 16K (2,048 x 8 or 1,024 x 16)

DATASHEET

Features

- Low-voltage Operation
 - V_{CC} = 1.8V to 5.5V
 - V_{CC} = 2.7V to 5.5V
- User-selectable Internal Organization
 - 16K: 2,048 x 8 or 1,024 x 16
- 3-wire Serial Interface
- Sequential Read Operation
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- 2MHz Clock Rate (5V)
- Self-timed Write Cycle (10ms Max)
- High Reliability
 - Endurance: 1,000,000 Write Cycles
 - Data Retention: 100 Years
- 8-lead JEDEC SOIC, 8-lead TSSOP, 8-pad UDFN, and 8-lead PDIP Packages

Description

The Atmel[®] AT93C86A provides 16,384 bits of Serial Electrically Erasable Programmable Read-Only Memory (EEPROM) organized as 1,024 words of 16 bits each (when the ORG pin is connected to V_{CC}) and 2,048 words of 8 bits each (when the ORG pin is tied to ground). The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operations are essential. The AT93C86A is available in space-saving 8-lead JEDEC SOIC, 8-lead TSSOP, 8-pad UDFN, and 8-lead PDIP packages.

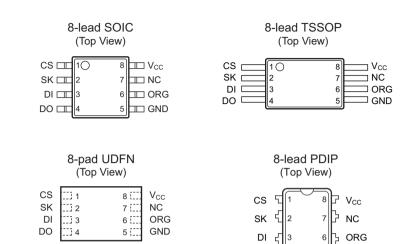
The AT93C86A is enabled through the Chip Select pin (CS) and accessed via a 3-wire serial interface consisting of Data Input (DI), Data Output (DO), and Shift Clock (SK). Upon receiving a Read instruction at DI, the address is decoded, and the data is clocked out serially on the DO pin. The write cycle is completely self-timed, and no separate erase cycle is required before Write. The write cycle is only enabled when the part is in the Erase/Write Enable state. When CS is brought high following the initiation of a write cycle, the DO pin outputs the Ready/Busy status of the part.

The AT93C86A operates from 1.8V to 5.5V or from 2.7V to 5.5V.

1. Pin Configurations and Pinouts

Table 1-1. Pin Configurations

| Pin Name | Function |
|-----------------|-----------------------|
| CS | Chip Select |
| SK | Serial Data Clock |
| DI | Serial Data Input |
| DO | Serial Data Output |
| GND | Ground |
| V _{CC} | Power Supply |
| ORG | Internal Organization |
| NC | No Connect |



Note: Drawings are not to scale.

2. Absolute Maximum Ratings*

| Operating Temperature55°C to +125°C |
|---|
| Storage Temperature |
| Voltage on any pin with respect to ground1.00V to +7.00V |
| Maximum Operating Voltage 6.25V |
| DC Output Current |

*Notice: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DO

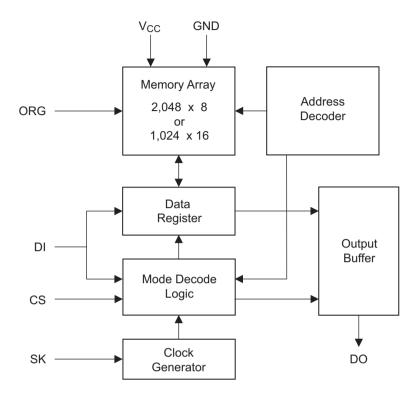
GND

5||凸



3. Block Diagram

Figure 3-1. Block Diagram



Note: When the ORG pin is connected to V_{CC} , the x16 organization is selected. When it is connected to ground, the x8 organization is selected. If the ORG pin is left unconnected, and the application does not load the input beyond the capability of the internal 1M Ω pull-up resistor, then the x16 organization is selected.



4. Memory Organization

4.1 Pin Capacitance

Table 4-1.Pin Capacitance⁽¹⁾

Applicable over recommended operating range from $T_A = 25^{\circ}C$, f = 1.0MHz, $V_{CC} = 5.0V$ (unless otherwise noted).

| Symbol | Test Conditions | Мах | Units | Conditions |
|------------------|--------------------------------|-----|-------|-----------------------|
| C _{OUT} | Output Capacitance (DO) | 5 | pF | V _{OUT} = 0V |
| C _{IN} | Input Capacitance (CS, SK, DI) | 5 | pF | V _{IN} = 0V |

Note: 1. This parameter is characterized, and is not 100% tested.

4.2 DC Characteristics

Table 4-2. DC Characteristics

Applicable over recommended operating range from $T_{AI} = -40^{\circ}$ C to $+85^{\circ}$ C, $V_{CC} = 1.8$ V to 5.5V (unless otherwise noted).

| Symbol | Parameter | Test Condition | | Min | Тур | Max | Unit |
|---------------------------------|---------------------|------------------------------|--------------------------|-----------------------|------|-----------------------|------|
| V _{CC1} | Supply Voltage | | | 1.8 | | 5.5 | V |
| V _{CC2} | Supply Voltage | | | 2.7 | | 5.5 | V |
| V _{CC3} | Supply Voltage | | | 4.5 | | 5.5 | V |
| | Supply Current | $\lambda = 5.0 \lambda$ | Read at 1.0MHz | | 0.5 | 2.0 | mA |
| I _{CC} | Supply Current | V _{CC} = 5.0V | Write at 1.0MHz | | 0.5 | 2.0 | mA |
| I _{SB1} | Standby Current | V _{CC} = 1.8V | CS = 0V | | 0.4 | 1.0 | μA |
| I _{SB2} | Standby Current | V _{CC} = 2.7V | CS = 0V | | 6.0 | 10.0 | μA |
| I _{SB3} | Standby Current | V _{CC} = 5.0V | CS = 0V | | 10.0 | 15.0 | μA |
| I _{IL} | Input Leakage | V_{IN} = 0V to V_{CC} | | | 0.1 | 3.0 | μA |
| I _{OL} | Output Leakage | V_{IN} = 0V to V_{CC} | | | 0.1 | 3.0 | μA |
| V _{IL1} ⁽¹⁾ | Input Low Voltage | $2.7V \leq V_{CC} \leq 5.5V$ | | -0.6 | | 0.8 | V |
| V _{IH1} ⁽¹⁾ | Input High Voltage | $2.7V \leq V_{CC} \leq 5.5V$ | | 2.0 | | V _{CC} + 1 | V |
| V _{IL2} ⁽¹⁾ | Input Low Voltage | $1.8V \leq V_{CC} \leq 2.7V$ | | -0.6 | | V _{CC} x 0.3 | V |
| V _{IH2} ⁽¹⁾ | Input High Voltage | $1.8V \leq V_{CC} \leq 2.7V$ | | V _{CC} x 0.7 | | V _{CC} + 1 | V |
| V _{OL1} | Output Low Voltage | $2.7V \leq V_{CC} \leq 5.5V$ | I _{OL} = 2.1mA | | | 0.4 | V |
| V _{OH1} | Output High Voltage | $2.7V \leq V_{CC} \leq 5.5V$ | I _{OH} = -0.4mA | 2.4 | | | V |
| V _{OL2} | Output Low Voltage | $1.8V \leq V_{CC} \leq 2.5V$ | I _{OL} = 0.15mA | | | 0.2 | V |
| V _{OH2} | Output High Voltage | $1.8V \leq V_{CC} \leq 2.7V$ | Ι _{ΟΗ} = -100μΑ | $V_{CC} - 0.2$ | | | V |

Note: 1. V_{IL} min and V_{IH} max are reference only, and are not tested.

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4.3 AC Characteristics

Table 4-3. AC Characteristics

Applicable over recommended operating range from $T_{AI} = -40^{\circ}$ C to + 85°C, CL = 1 TTL gate and 100pF (unless otherwise noted).

| Symbol | Parameter | Test Condition | | Min | Тур | Max | Units |
|--------------------------|---------------------|------------------------------|--------------------------------|------|-----------|------|-----------------|
| | | $4.5V \le V_{CC} \le 5.$ | 5V | 0 | | 2 | MHz |
| f _{sк} | SK Clock Frequency | $2.7V \le V_{CC} \le 5.$ | 5V | 0 | | 1 | MHz |
| | | $1.8V \leq V_{CC} \leq 5.5V$ | | 0 | | 250 | kHz |
| | | $2.7V \le V_{CC} \le 5.$ | 5V | 250 | | | ns |
| t _{skh} | SK High Time | $1.8V \le V_{CC} \le 5.$ | 5V | 1000 | | | ns |
| | | $2.7V \le V_{CC} \le 5.$ | 5V | 250 | | | ns |
| t _{SKL} | SK Low Time | $1.8V \le V_{CC} \le 5.$ | 5V | 1000 | | | ns |
| | Minimum CC Law Time | $2.7V \leq V_{CC} \leq 5.$ | 5V | 250 | | | ns |
| t _{cs} | Minimum CS Low Time | $1.8V \le V_{CC} \le 5.$ | 5V | 1000 | | | ns |
| | CC Coture Time | Deletive to CK | $2.7V \leq V_{CC} \ \leq 5.5V$ | 50 | | | ns |
| t _{CSS} | CS Setup Time | Relative to SK | $1.8V \leq V_{CC} \ \leq 5.5V$ | 200 | | | ns |
| | | Deletive to CK | $2.7V \leq V_{CC} \ \leq 5.5V$ | 100 | | | ns |
| t _{DIS} | DI Setup Time | Relative to SK | $1.8V \leq V_{CC} \ \leq 5.5V$ | 400 | | | ns |
| t _{CSH} | CS Hold Time | Relative to SK | | 0 | | | ns |
| | DI Hold Time | Deletive to SK | $2.7V \leq V_{CC} \ \leq 5.5V$ | 100 | | | ns |
| t _{DIH} | DI Hold Time | Relative to SK | $1.8V \leq V_{CC} \ \leq 5.5V$ | 400 | | | ns |
| | Output Delay to 1 | AC Test | $2.7V \leq V_{CC} \ \leq 5.5V$ | | | 250 | ns |
| t _{PD1} | Output Delay to 1 | AC Test | $1.8V \leq V_{CC} \ \leq 5.5V$ | | | 1000 | ns |
| | Output Delay to 0 | AC Test | $2.7V \leq V_{CC} \ \leq 5.5V$ | | | 250 | ns |
| t _{PD0} | Output Delay to 0 | AC Test | $1.8V \leq V_{CC} \ \leq 5.5V$ | | | 1000 | ns |
| | CC to Status Valid | AC Test | $2.7V \leq V_{CC} \ \leq 5.5V$ | | | 250 | ns |
| t _{sv} | CS to Status Valid | AC Test | $1.8V \leq V_{CC} \ \leq 5.5V$ | | | 1000 | ns |
| + | CS to DO in | AC Test | $2.7V \leq V_{CC} \ \leq 5.5V$ | | | 150 | ns |
| t _{DF} | High-impedance | CS = V _{IL} | $1.8V \leq V_{CC} \ \leq 5.5V$ | | | 400 | ns |
| t _{WP} | Write Cycle Time | | $1.8V \leq V_{CC} \ \leq 5.5V$ | 0.1 | 3 | 10 | ms |
| Endurance ⁽¹⁾ | 5.0V, 25°C | | | | 1,000,000 |) | Write Cycles |

Note: 1. This parameter is characterized, and is not 100% tested.



5. Functional Description

The AT93C86A is accessed via a simple and versatile 3-wire serial communication interface. Device operation is controlled by seven instructions issued by the Host processor. A valid instruction starts with a rising edge of CS and consists of a Start bit (Logic 1), followed by the appropriate opcode, and the desired memory address location.

| | | | Addr | ess | Da | ata | |
|-------------|----|--------|----------------------------------|---------------------------|---------------------------------|----------------------------------|--|
| Instruction | SB | Opcode | x8 ⁽¹⁾ | x16 ⁽¹⁾ | x 8 | x16 | Comments |
| READ | 1 | 10 | $A_{10} - A_0$ | $A_9 - A_0$ | | | Reads data stored in memory at specified address. |
| EWEN | 1 | 00 | 11XXXXXXX | 11XXXXXX | | | Write Enable must precede all programming modes. |
| ERASE | 1 | 11 | A ₁₀ - A ₀ | $A_9 - A_0$ | | | Erases memory location $A_N - A_0$. |
| WRITE | 1 | 01 | $A_{10} - A_0$ | $A_9 - A_0$ | D ₇ – D ₀ | D ₁₅ – D ₀ | Writes memory location $A_N - A_0$. |
| ERAL | 1 | 00 | 10XXXXXXX | 10XXXXXX | | | Erases all memory locations. Valid only at V_{CC} = 4.5V to 5.5V. |
| WRAL | 1 | 00 | 01XXXXXXX | 01XXXXXX | $D_7 - D_0$ | D ₁₅ -D ₀ | Writes all memory locations. Valid only at V_{CC} = 4.5V to 5.5V and Disable Register cleared. |
| EWDS | 1 | 00 | 00XXXXXXX | 00XXXXXX | | | Disables all programming instructions. |

| Table 5-1. | AT93C86A | Instruction | Set |
|------------|----------|-------------|-----|
| | | | |

Note: 1. The 'X' in the address field represent don't care values, and must be clocked.

READ: The READ instruction contains the address code for the memory location to be read. After the instruction and address are decoded, data from the selected memory location is available at the Serial Output pin, DO. Output data changes are synchronized with the rising edges of the Serial Clock pin, SK. It should be noted that a dummy bit (Logic 0) precedes the 8-bit or 16-bit data output string. The AT93C86A supports sequential Read operations. The device will automatically increment the internal address pointer and clock out the next memory location as long as Chip Select (CS) is held high. In this case, the dummy bit (Logic 0) will not be clocked out between memory locations, thus allowing for a continuous stream of data to be read.

Erase/Write Enable (EWEN): To ensure data integrity, the part automatically goes into the Erase/Write Disable (EWDS) state when power is first applied. An Erase/Write Enable (EWEN) instruction must be executed first before any programming instructions can be carried out.

Note: Once in the EWEN state, programming remains enabled until an EWDS instruction is executed, or V_{CC} power is removed from the part.



ERASE: The ERASE instruction programs all bits in the specified memory location to the Logic 1 state. The self-timed erase cycle starts once the ERASE instruction and address are decoded. The DO pin outputs the Ready/Busy status of the part if CS is brought high after being kept low for a minimum of t_{CS} . A Logic 1 at the DO pin indicates that the selected memory location has been erased, and the part is ready for another instruction.

WRITE: The WRITE instruction contains the 8-bits or 16-bits of data to be written into the specified memory location. The self-timed programming cycle, t_{WP} , starts after the last bit of data is received at Serial Data Input pin DI. The DO pin outputs the Ready/Busy status of the part if CS is brought high after being kept low for a minimum of t_{CS} . A Logic 0 at DO indicates that programming is still in progress. A Logic 1 indicates that the memory location at the specified address has been written with the data pattern contained in the instruction, and the part is ready for further instructions. A Ready/Busy status cannot be obtained if CS is brought high after the end of the self-timed programming cycle, t_{WP} .

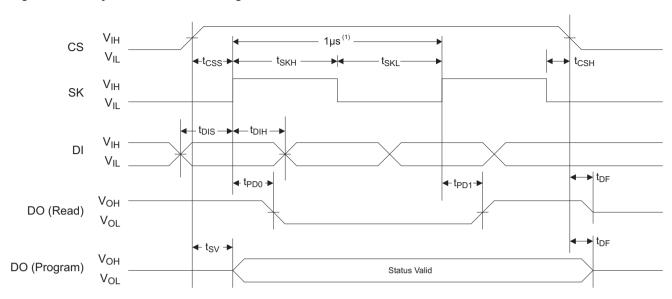
Erase All (ERAL): The Erase All (ERAL) instruction programs every bit in the Memory Array to the Logic 1 state and is primarily used for testing purposes. The DO pin outputs the ready/busy status of the part if CS is brought high after being kept low for a minimum of t_{CS} . The ERAL instruction is valid only at $V_{CC} = 5.0V \pm 10\%$.

Write All (WRAL): The Write All (WRAL) instruction programs all memory locations with the data patterns specified in the instruction. The DO pin outputs the Ready/Busy status of the part if CS is brought high after being kept low for a minimum of t_{CS} . The WRAL instruction is valid only at $V_{CC} = 5.0V \pm 10\%$.

Erase/Write Disable (EWDS): To protect against accidental data disturbance, the Erase/Write Disable (EWDS) instruction disables all programming modes and should be executed after all programming operations. The operation of the Read instruction is independent of both the EWEN and EWDS instructions and can be executed at any time.



6. Timing Diagrams



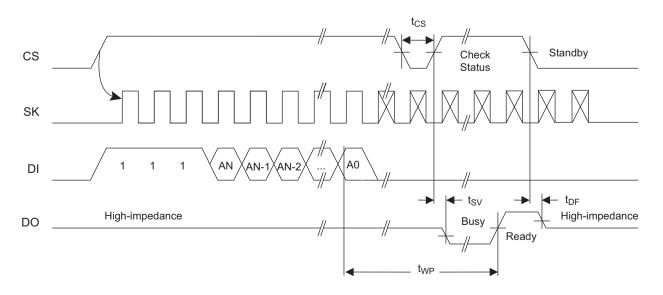


Note: 1. This is the minimum SK period.

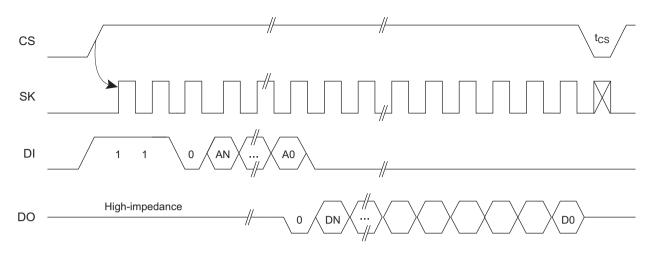
Table 6-1. Organization Key for Timing Diagrams

| | AT93C8 | 6A (16K) |
|----------------|-----------------|-----------------|
| I/O | x8 | x16 |
| A _N | A ₁₀ | A ₉ |
| D _N | D ₇ | D ₁₅ |

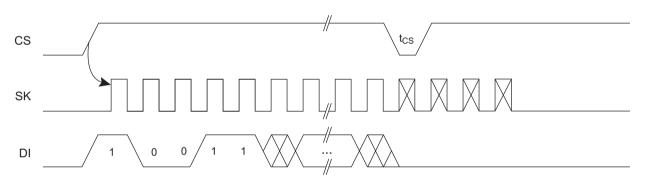




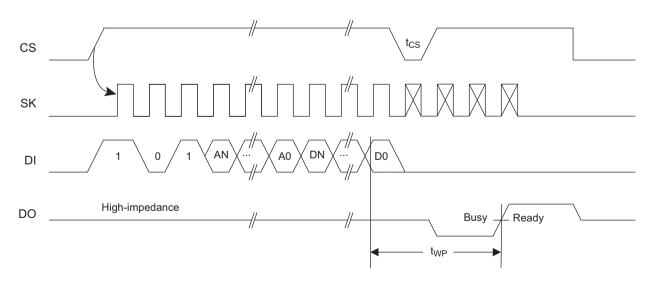
8 AT93C86A [DATASHEET] Atmel-3408L-SEEPROM-AT93C86A-Datasheet_012017 Figure 6-3. READ Timing





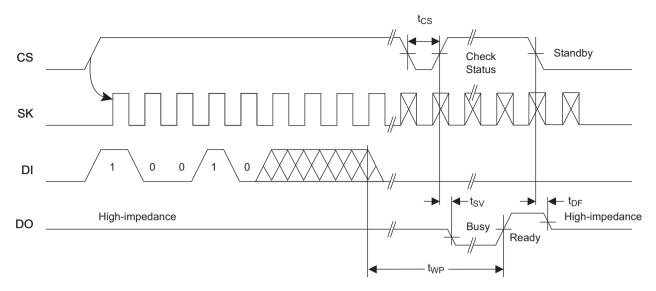




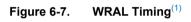


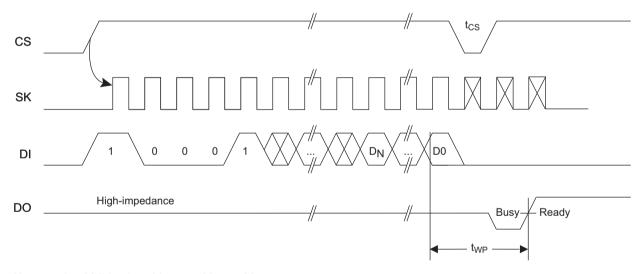






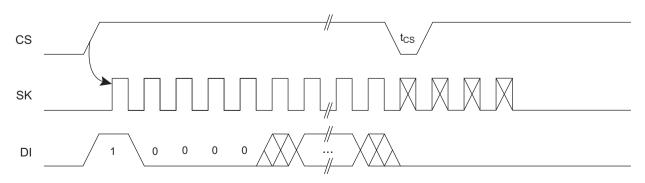
Note: 1. $V_{CC} = 4.5V$ to 5.5V.





Note: 1. Valid only at V_{CC} = 4.5V to 5.5V.

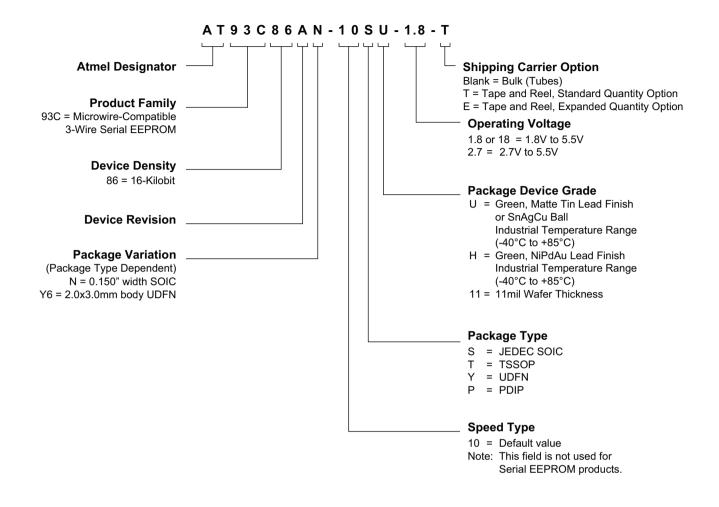




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7. Ordering Code Detail





8. Part Markings

| | 8-lead SOI | с | 8-lead TSSOP | | | |
|---|--|--|--|--|---|---|
| | Note: Lot Numbe | | U% AT### Note: Lot Number, location of assemt YWW date code on the bottom of the package. | ly and lide of | | |
| | 8-pad UDF | N | 8-lead PDIP | | | |
| | H | dy # # # 18 & XX | ATMLUYWW 93C86A PU%% Cr Cr Cr Cr Note: Lot Number and location of ass on the bottom side of the packa | embly ge. | | |
| | Note 1: designates p Note 2: Package drawin | | I | | | |
| Catalog Number Trunca AT93C86A | Note 2: Package drawin, | gs are not to scale | n Code ###: 86A |] | | |
| AT93C86A Date Codes | Note 2: Package drawin tion | gs are not to scale | | Voltage | | |
| AT93C86A Date Codes Y = Year 4: 2014 8: 2018 5: 2015 9: 2019 6: 2016 0: 2020 | Mete 2: Package drawin tion M = Month A: January B: February | Truncation WW = Wo 02: Week 04: Week | rk Week of Assembly 2 4 | % = 3 or 27: | | |
| AT93C86A Date Codes Y = Year 4: 2014 8: 2018 5: 2015 9: 2019 | Met 2: Package drawin tion M = Month A: January B: February L: December | gs are not to scale Truncation WW = Wo 02: Week | rk Week of Assembly 2 4 | % = 3 or 27: 1 or 18: | = Minimu 2.7V mi 1.8V mi | in |
| AT93C86A Date Codes Y = Year 4: 2014 8: 2018 5: 2015 9: 2019 6: 2016 0: 2020 7: 2017 1: 2021 | M = Month A: January B: February L: December Lot | Truncation WW = Wo 02: Week 04: Week 52: Week | rk Week of Assembly 2 4 52 | % = 3 or 27: 1 or 18: Grade/L H: | = Minimu 2.7V mi 1.8V mi .ead Fini Industri | in in |
| AT93C86A Date Codes Y = Year 4: 2014 8: 2018 5: 2015 9: 2019 6: 2016 0: 2020 7: 2017 1: 2021 Country of Assembly | M = Month A: January B: February L: December Lot | ss are not to scale Truncation WW = Wo 02: Week 04: Week 52: Week t Number | rk Week of Assembly 2 4 52 | % = 3 or 27: 1 or 18: Grade/L H: U: | = Minimu 2.7V mi 1.8V mi .ead Fini Industri | in i sh Material ial/NiPdAu ial/Matte Tin/Sn/ |
| AT93C86A Date Codes Y = Year 4: 2014 8: 2018 5: 2015 9: 2019 6: 2016 0: 2020 7: 2017 1: 2021 Country of Assembly @ = Country of Assembly | Note 2: Package drawin tion M = Month A: January B: February L: December Lot AA | Truncation Truncation WW = Wo 02: Week 04: Week 52: Week t Number AA = Atmel Wa | rk Week of Assembly 2 4 52 | % = 3 or 27: 1 or 18: Grade/L H: U: U: Atmel T AT: | Minimu 2.7V mi 1.8V mi .ead Fini Industri Industri Industri Truncatio Atmel Atmel | in i sh Material ial/NiPdAu ial/Matte Tin/Sn/ |
| AT93C86A Date Codes Y = Year 4: 2014 8: 2018 5: 2015 9: 2019 6: 2016 0: 2020 7: 2017 1: 2021 Country of Assembly @ = Country of Assembly Trace Code XX = Trace Code (Atmel) | Note 2: Package drawin tion M = Month A: January B: February L: December Lot AA | Truncation Truncation WW = Wo 02: Week 04: Week 52: Week t Number AA = Atmel Wa | rk Week of Assembly 2 4 52 | % = 3 or 27: 1 or 18: Grade/L H: U: U: Atmel T AT: ATM: | Minimu 2.7V mi 1.8V mi Lead Fini Industri Industri Industri Truncatio Atmel Atmel Atmel | in i sh Material ial/NiPdAu ial/Matte Tin/Sn/ |

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9. Ordering Information

| | Lead | | | Delivery I | nformation | Operation | |
|-------------------------|------------------------|---------|-----------------------------|---------------|-----------------|--|--|
| Atmel Ordering Code (1) | Finish | Package | Voltage | Form | Quantity | Range | |
| AT93C86A-10SU-1.8 | | | 1.8V to 5.5V | Bulk (Tubes) | 100 per Tube | Industrial Temperature (-40°C to 85°C) | |
| AT93C86A-10SU-1.8-T | | | 8S1 | 1.8V to 5.5V | Tape and Reel | 4,000 per Reel | |
| AT93C86A-10SU-2.7 | | | 2.7V to 5.5V ⁽¹⁾ | Bulk (Tubes) | 100 per Tube | | |
| AT93C86A-10SU-2.7-T | | | 2.7V to 5.5V ⁽¹⁾ | Tape and Reel | 4,000 per Reel | | |
| AT93C86A-10TU-1.8 | Matte Tin Lead-free | | 1.8V to 5.5V | Bulk (Tubes) | 100 per Tube | | |
| AT93C86A-10TU-1.8-T | Halogen-free | 8X | 1.8V to 5.5V | Tape and Reel | 5,000 per Reel | | |
| AT93C86A-10TU-2.7 | _ | 87 | 2.7V to 5.5V ⁽¹⁾ | Bulk (Tubes) | 100 per Tube | | |
| AT93C86A-10TU-2.7-T | | | 2.7V to 5.5V ⁽¹⁾ | Tape and Reel | 5,000 per Reel | | |
| AT93C86A-10PU-1.8 | | 8P3 | 1.8V to 5.5V | Bulk (Tubes) | 50 per Tube | | |
| AT93C86A-10PU-2.7 | | 013 | 2.7V to 5.5V ⁽¹⁾ | Bulk (Tubes) | 50 per Tube | | |
| AT93C86AY6-10YH-1.8-T | NiPdAu Lead-free | 8MA2 | 1.8V to 5.5V | Tape and Reel | 5,000 per Reel | | |
| AT93C86AY6-10YH-18-E | Halogen-free | | 1.00 10 0.00 | Tape and Reel | 15,000 per Reel | | |

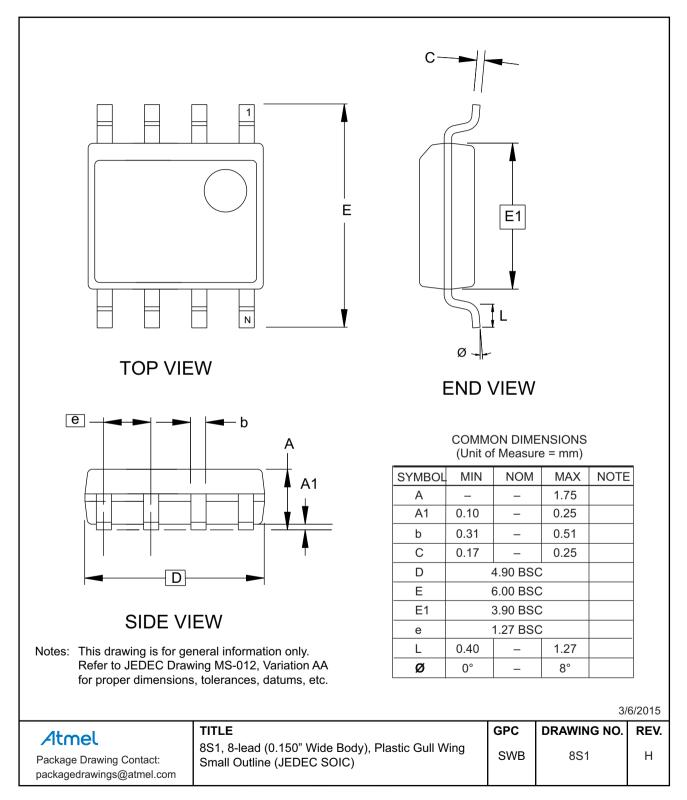
Notes: 1. For 2.7V devices used in a 4.5V to 5.5V range, please refer to performance values in Section 4.2, "DC Characteristics" and 4.3, "AC Characteristics" on page 5.

| | Package Type |
|------|---|
| 8S1 | 8-lead, 0.150" wide, Plastic Gull Wing, Small Outline (JEDEC SOIC) |
| 8X | 8-lead, 0.170" wide, Thin Shrink Small Outline (TSSOP) |
| 8P3 | 8-lead, 0.300" wide body, Plastic Dual In-line Package (PDIP) |
| 8MA2 | 8-pad, 2.00mm x 3.00mm body, 0.50mm pitch, Ultra Thin Dual No Lead (UDFN) |



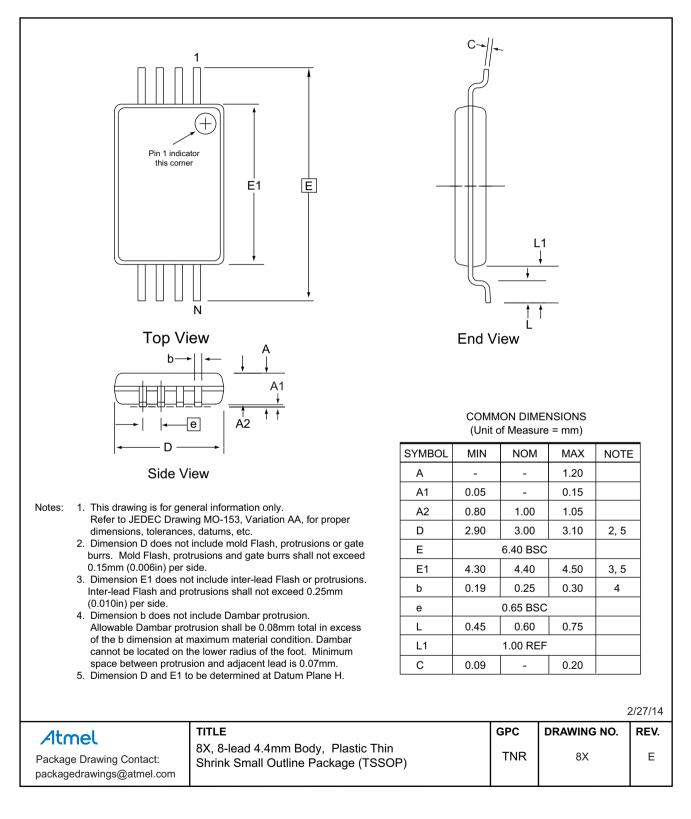
10. Packaging Information

10.1 8S1 — 8-lead JEDEC SOIC



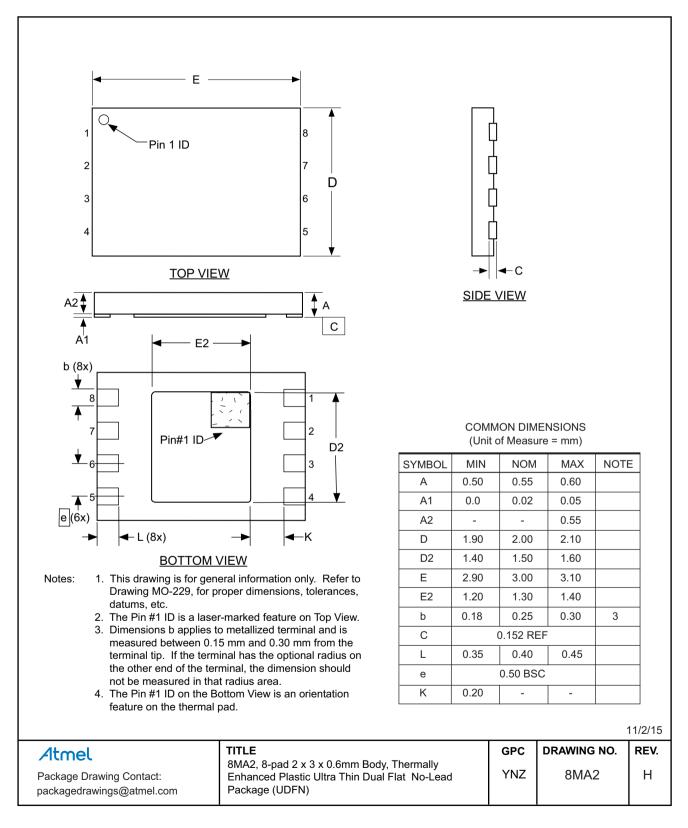


10.2 8X — 8-lead TSSOP



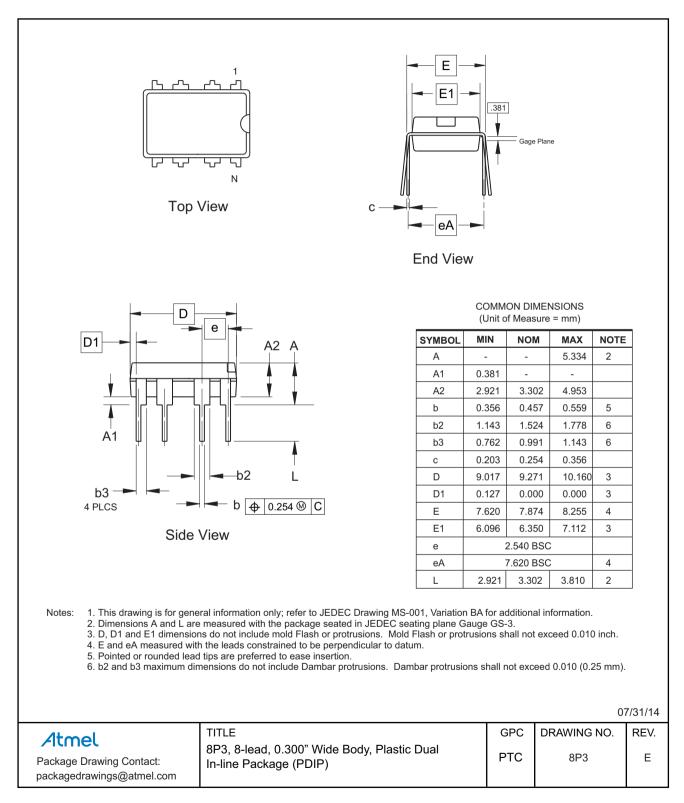






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11. Revision History

| Revision No. | Date | Comments |
|--------------|---------|---|
| 3408L | 01/2017 | Added Bulk (Tube) Shipping Carrier Option Changed Standard Quantity Tape and Reel Option to "T" Updated Ordering Information Table Removed AT93C86A-W1.8-11 Part Number |
| 3408K | 12/2015 | Correct Ordering Code Detail and update the 8S1 and 8MA2 package drawings. |
| 3408J | 01/2015 | Add the UDFN extended quantity option and update the ordering information section. Update the 8MA2 and 8P3 package drawings. |
| 34081 | 08/2014 | Update pinouts, 8MA2 package drawing, grammatical changes, document template, logos, and disclaimer page. No changes to functional specification. |
| 3408H | 01/2007 | Add "Bottom View" to page 1 Ultra Thin MiniMap package drawing page 4 revise Note 1 added "ensured by characterization". |
| 3408G | 07/2006 | Revision history implemented. Delete 'Preliminary' status from datasheet; Add 'Ultra Thin' description to MLP 2x3 package; Delete '1.8V not available' on Figure 1 Note; Add 1.8V range on Table 4 under Write Cycle Time. |



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